TOSHIBA Insulated Gate Bipolar Transistor Silicon N Channel IGBT

# GT40T301

### Parallel Resonance Inverter Switching Applications

Unit: mm

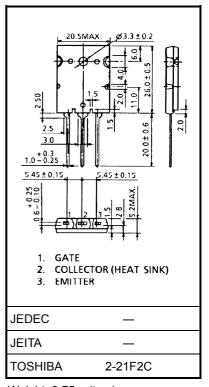
- FRD included between emitter and collector
- Enhancement-mode
- High speed IGBT :  $t_f = 0.25 \mu s$  (typ.) (IC = 40 A)

FRD :  $t_{rr} = 0.7 \mu s$  (typ.) (di/dt = -20 A/ $\mu s$ )

• Low saturation voltage: VCE (sat) = 3.7 V (typ.) (IC = 40 A)

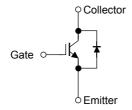
#### Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Collector-emitter voltage		V <sub>CES</sub>	1500	V	
Gate-emitter voltage	V <sub>GES</sub>	±25	V		
Collector current	DC	IC	40	Α	
	1 ms	I <sub>CP</sub>	80		
Emitter-collector forward current	DC	I <sub>ECF</sub>	30	А	
	1 ms	I <sub>ECPF</sub>	80		
Collector power dissipation (Tc = 25°C)		PC	200	W	
Junction temperature		Tj	150	°C	
Storage temperature range		T <sub>stg</sub>	<b>−55~150</b>	°C	



Weight: 9.75 g (typ.)

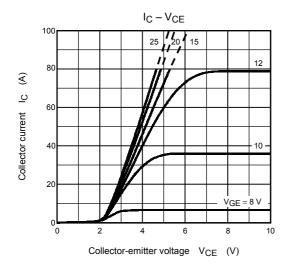
#### **Equivalent Circuit**

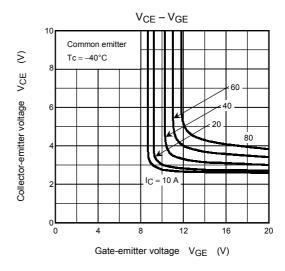


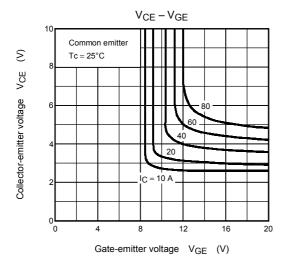
## Electrical Characteristics (Ta = 25°C)

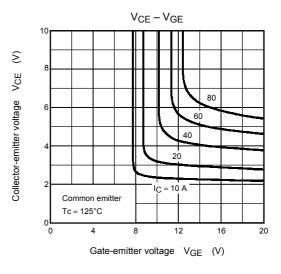
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I <sub>GES</sub>	$V_{GE} = \pm 25 \text{ V}, V_{CE} = 0$	_	_	±500	nA
Collector cut-off current		I <sub>CES</sub>	V <sub>CE</sub> = 1500 V, V <sub>GE</sub> = 0	_	_	1.0	mA
Gate-emitter cut-off voltage		V <sub>GE</sub> (OFF)	$I_C = 40$ mA, $V_{CE} = 5$ V	4.0	_	7.0	V
Collector-emitter saturation voltage		V <sub>CE</sub> (sat)	I <sub>C</sub> = 40 A, V <sub>GE</sub> = 15 V	_	3.7	5.0	V
Input capacitance		C <sub>ies</sub>	V <sub>CE</sub> = 10 V, V <sub>GE</sub> = 0, f = 1 MHz	_	2900	_	pF
Switching time	Rise time	t <sub>r</sub>	15 V S S S S S S S S S S S S S S S S S S	_	0.40	_	μs
	Turn-on time	t <sub>on</sub>			0.45	_	
	Fall time	t <sub>f</sub>			0.23	0.40	
	Turn-off time	t <sub>off</sub>		_	0.6	_	
Emitter-collector forward voltage		V <sub>ECF</sub>	I <sub>ECF</sub> = 30 A, V <sub>GE</sub> = 0		1.9	2.5	٧
Reverse recovery time		t <sub>rr</sub>	$I_{ECF} = 30 \text{ A}, V_{GE} = 0, di/dt = -20 \text{ A/}\mu\text{s}$	_	0.7	3.0	μs
Thermal resistance		R <sub>th (j-c)</sub>	IGBT	_	_	0.625	°C/W
			Diode	_		1.25	

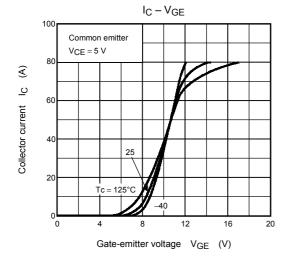
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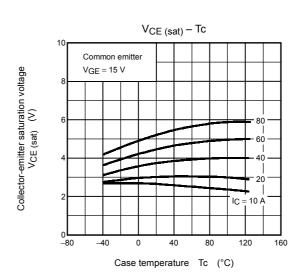




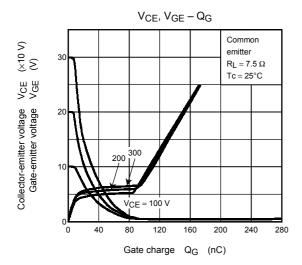


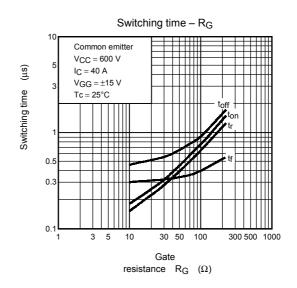


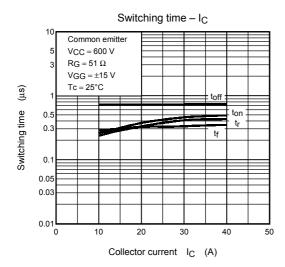


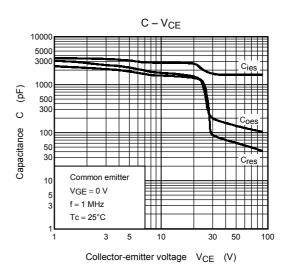


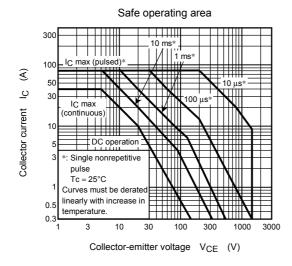
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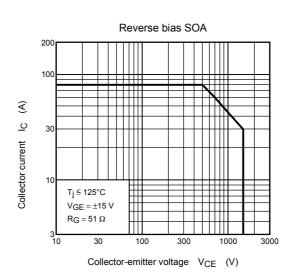




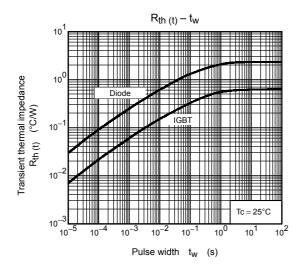


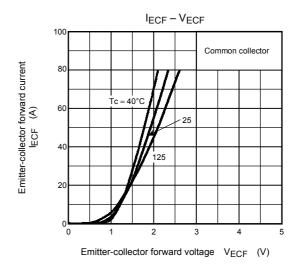


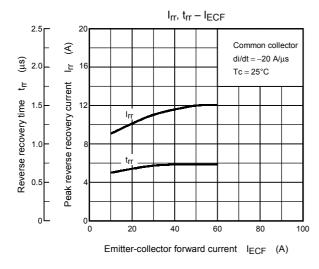


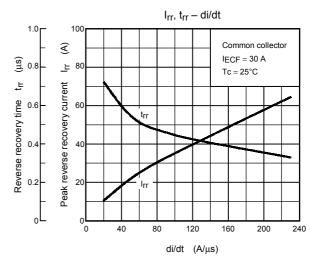


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